

INTERNATIONAL GEMOLOGICAL INSTITUTE

ELECTRONIC COPY

LABORATORY GROWN DIAMOND REPORT

October 10, 2023		
IGI Report Number	LG602359253	
Description	LABORATORY GROWN DIAMOND	
Shape and Cutting Style	PRINCESS CUT	
Measurements	5.95 X 5.83 X 4.08 MM	
GRADING RESULTS		
Carat Weight	1.21 CARAT	
Color Grade	G	
Clarity Grade	VS 1	
ADDITIONAL GRADING INFORMATION		
Polish	EXCELLENT	

1 01311	LACELLENI
Symmetry	EXCELLENT
Fluorescence	NONE
Inscription(s)	(131 LG602359253

Comments: This Laboratory Grown Diamond was created by Chemical Vapor Deposition (CVD) growth process and may include post-growth treatment. Type IIa

LABORATORY GROWN DIAMOND REPORT

LG602359253 Report verification at igi.org

67%

Pointed

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70%

PROPORTIONS

Medium To

Slightly Thick

-

9.5%

57.5%

CLARITY CHARACTERISTICS

KEY TO SYMBOLS

Red symbols indicate internal characteristics. Green symbols indicate external characteristics.

 \checkmark

LABORATORY GROWN DIAMOND REPORT

GRADING SCALES

CLARITY

IF	VVS ¹⁻²	VS ¹⁻²	SI ¹⁻²	l ¹⁻³
Internally	Very Very	Very	Slightly	Included
Flawless	Slightly Included	Slightly Included	Included	

COLOR

D E F G H I J Faint Very Light	Light
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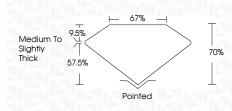


Sample Image Used

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O-t-b -- 10 000

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